

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	267		2	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		3	
		18	L2		
C-RS-FR4-ML-0.254mm-018+018-TG150-HF-...	50203053	254		4	A01
		18	L3		
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	260		5	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		6	
		18	L4		
C-RS-FR4-ML-0.254mm-018+018-TG150-HF-...	50203053	254		7	A02
		18	L5		B00
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	260		8	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		9	
		18	L6		
C-RS-FR4-ML-0.254mm-018+018-TG150-HF-...	50203053	254		10	A03
		18	L7		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	267		11	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		12	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	13	

Thickness after Pressing

B00:

1890 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2090 µm

Dmin:

1690 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2000 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2200 µm

Dmin:

1800 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

1960 µm

Version 1.2.20.35

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